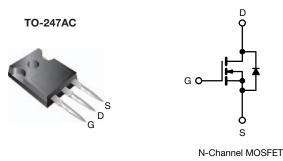
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.28			
Q _g max. (nC)	78				
Q _{gs} (nC)	9				
Q _{gd} (nC)	17				
Configuration	Single				



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG15N60E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)								
PARAMETER			SYMBOL	LIMIT	UNIT			
Drain-Source Voltage			V _{DS}	600	V			
Gate-Source Voltage			V _{GS}	± 30	V			
Continuous Drain Current (T _J = 150 °C)	V + 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		15				
	V _{GS} at 10 V	T _C = 100 °C	I _D	9.6	А			
Pulsed Drain Current ^a			I _{DM}	39				
Linear Derating Factor				1.4	W/°C			
Single Pulse Avalanche Energy ^b			E _{AS}	102	mJ			
Maximum Power Dissipation			PD	180	W			
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C			
Drain-Source Voltage Slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		70		N//			
Reverse Diode dV/dt d			dV/dt	7.7	V/ns			
Soldering Recommendations (Peak temperature) ^c	for 10 s			300	°C			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 11.6 mH, R_g = 25 Ω , I_{AS} = 4.2 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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COMPLIANT HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	- 62					
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.7				°C/W		
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNIT
Static					1	I	L	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I	$_{\rm D} = 1 \rm{mA}$	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2	-	4	V
			$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	,			-	-	± 1	μA
Zero Gate Voltage Drain Current		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	1	
	I _{DSS}	V _{DS} = 480 V	⁷ , V _{GS} = 0 V,	T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V) = 8 A	-	0.23	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	8 A	-	4.6	-	S
Dynamic		-						<u>.</u>
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	1350	-	pF	
Output Capacitance	C _{oss}			-	70	-		
Reverse Transfer Capacitance	C _{rss}			-	5	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	53	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			_	177	-		
Total Gate Charge	Qg				-	39	78	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 8 A, V _{DS} = 480 V		-	11	-	nC
Gate-Drain Charge	Q _{gd}				-	17	-	
Turn-On Delay Time	t _{d(on)}				-	16	32	
Rise Time	t _r	Voo	V_{DD} = 480 V, I _D = 8 A, V _{GS} = 10 V, R _q = 9.1 Ω		-	26	52	ns
Turn-Off Delay Time	t _{d(off)}				-	41	82	
Fall Time	t _f				-	22	44	
Gate Input Resistance	Rg	f = 1	MHz, open	drain	0.3	0.86	1.7	Ω
Drain-Source Body Diode Characteristic	-				_			
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15		
Pulsed Diode Forward Current	I _{SM}			-	-	60	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	1.0	1.2	V	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 8 \text{ A,}$ $dI/dt = 100 \text{ A}/\mu\text{s, } V_{R} = 25 \text{ V}$		-	302	604	ns	
Reverse Recovery Charge	Q _{rr}			-	4.0	8	μC	
Reverse Recovery Current	I _{RRM}			-	24	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

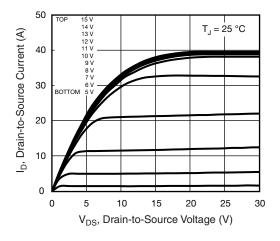


Fig. 1 - Typical Output Characteristics

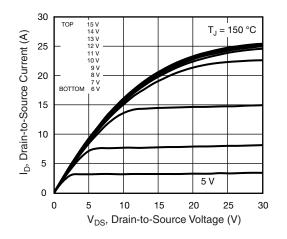


Fig. 2 - Typical Output Characteristics

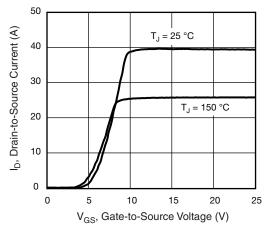


Fig. 3 - Typical Transfer Characteristics

 $(p_{i})_{i}$ 2.5 $(p_{i})_{i}$

3

Fig. 4 - Normalized On-Resistance vs. Temperature

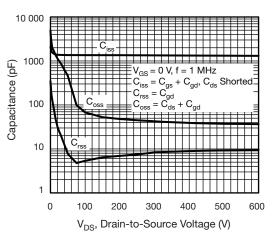


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

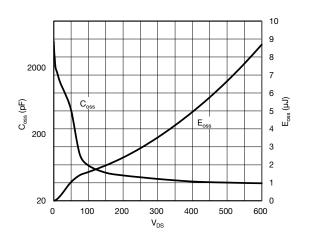


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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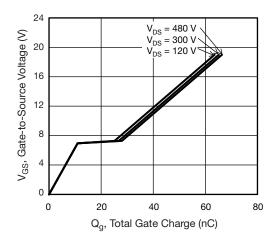


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

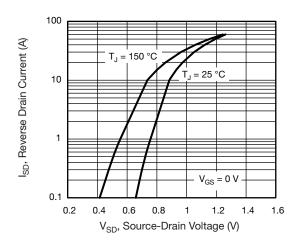


Fig. 8 - Typical Source-Drain Diode Forward Voltage

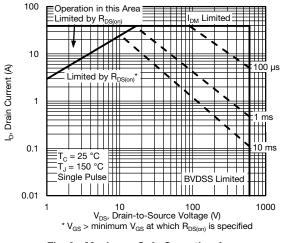


Fig. 9 - Maximum Safe Operating Area

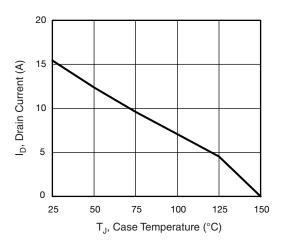


Fig. 10 - Maximum Drain Current vs. Case Temperature

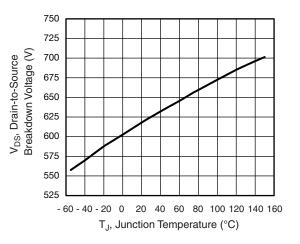
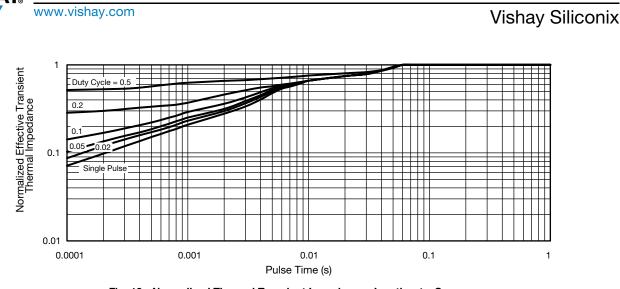


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4





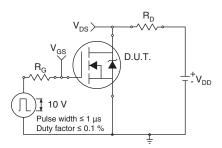


Fig. 13 - Switching Time Test Circuit

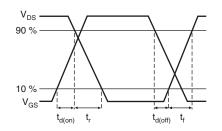


Fig. 14 - Switching Time Waveforms

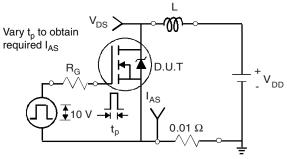


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

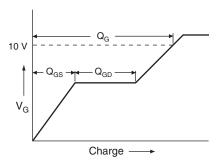


Fig. 17 - Basic Gate Charge Waveform

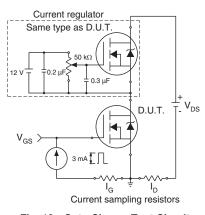


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

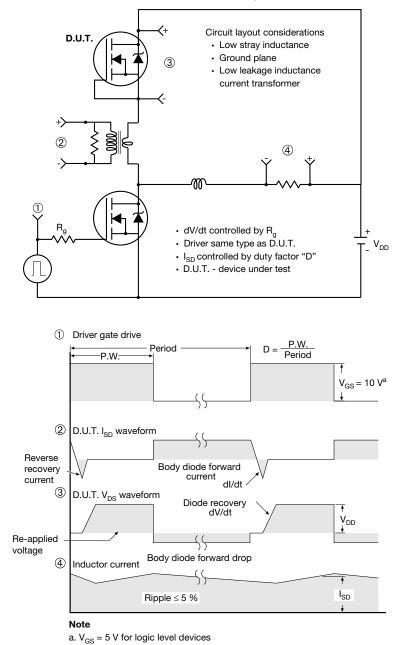


Fig. 19 - For N-Channel

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